

#### LM2931

## **Series Low Dropout Regulators**

#### **General Description**

The LM2931 positive voltage regulator features a very low quiescent current of 1mA or less when supplying 10mA loads. This unique characteristic and the extremely low input-output differential required for proper regulation (0.2V for output currents of 10mA) make the LM2931 the ideal regulator for standby power systems. Applications include memory standby circuits, CMOS and other low power processor power supplies as well as systems demanding as much as 100mA of output current.

Designed originally for automotive applications, the LM2931 and all regulated circuitry are protected from reverse battery installations or 2 battery jumps. During line transients, such as a load dump (60V) when the input voltage to the regulator can momentarily exceed the specified maximum operating voltage, the regulator will automatically shut down to protect both internal circuits and the load. The LM2931 cannot be harmed by temporary mirror-image insertion. Familiar regulator features such as short circuit and thermal overload protection are also provided.

The LM2931 family includes a fixed 5V output (±3.8% tolerance for A grade) or an adjustable output with ON/OFF pin.

Both versions are available in a TO-220 power package, TO-263 surface mount package, and an 8-lead surface mount package. The fixed output version is also available in the TO-92 plastic package.

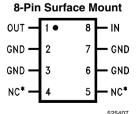
#### **Features**

- Very low quiescent current
- Output current in excess of 100 mA
- Input-output differential less than 0.6V
- Reverse battery protection
- 60V load dump protection
- -50V reverse transient protection
- Short circuit protection
- Internal thermal overload protection
- Mirror-image insertion protection
- Available in TO-220, TO-92, TO-263, or SO-8 packages
- Available as adjustable with TTL compatible switch

#### **Connection Diagrams**

#### **FIXED VOLTAGE OUTPUT**

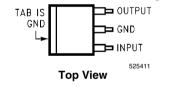
# TO-220 3-Lead Power Package OUT GND IN Front View Side View

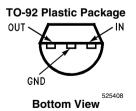


\*NC = Not internally connected. Must be electrically isolated from the rest of the circuit for the micro SMD package.

**Top View** 

#### **TO-263 Surface-Mount Package**





# 6-Bump micro SMD NC\* GND NC\* A2 B2 C2 A1 B1 C1 OUT NC\* IN Top View (Bump Side Down)

X = Date Code

X

Pin A1 Identifier

525439

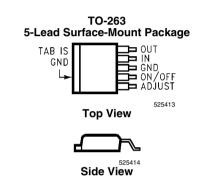
micro SMD Laser Mark

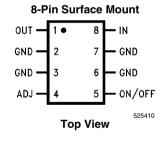
**ADJUSTABLE OUTPUT VOLTAGE** 

TO-220 5-Lead Power Package

5 0UT
4 IN
3 GND
2 0N/0FF
1 ADJUST

525409



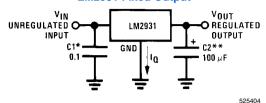


# **Ordering Information**

Output Voltage	Package Type	NSC Drawing	Order Number	Package Marking	Transport Media
	8-Pin SOIC Narrow	M08A	LM2931AM-5.0	2931A M-5.0	Rail of 95
			LM2931AMX-5.0	2931A M-5.0	Reel of 2500
			LM2931M-5.0	2931 M-5.0	Rail of 95
			LM2931MX-5.0	2931 M-5.0	Reel of 2500
	3-Pin TO-220	Т03В	LM2931AT-5.0	LM2931 AT5.0	Rail of 45
5V			LM2931T-5.0	LM2931T 5.0	Rail of 45
	3-Pin TO-263	TS3B	LM2931AS-5.0	LM2931 AS5.0	Rail of 45
			LM2931ASX-5.0	LM2931 AS5.0	Reel of 500
			LM2931S-5.0	LM2931S 5.0	Rail of 45
	3-Pin TO-92	Z03A	LM2931AZ-5.0	LM293 1AZ-5	Box of 1800
			LM2931Z-5.0	LM293 1Z-5	Box of 1800
	8-Pin SOIC Narrow	DIC M08A	LM2931CM	LM29 31CM	Rail of 95
Adjustable			LM2931CMX	LM29 31CM	Reel of 2500
3V to 24V	5-Pin TO-220	T05A	LM2931CT	LM2931CT	Rail of 45
	5-Pin TO-263	TS5B	LM2931CS	LM2931CS	Rail of 45

# **Typical Applications**

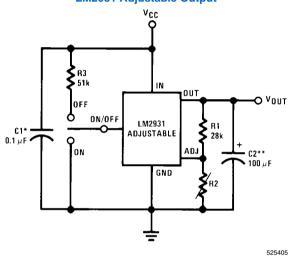
#### **LM2931 Fixed Output**



\*Required if regulator is located far from power supply filter.

\*\*C2 must be at least 100 µF to maintain stability. May be increased without bound to maintain regulation during transients. Locate as close as possible to the regulator. This capacitor must be rated over the same operating temperature range as the regulator. The equivalent series resistance (ESR) of this capacitor is critical; see curve.

#### LM2931 Adjustable Output



 $V_{OUT} = Reference Voltage \times \frac{R1 + R2}{R1}$ 

Note: Using 27k for R1 will automatically compensate for errors in  $V_{OUT}$  due to the input bias current of the ADJ pin (approximately 1  $\mu$ A).

2000V

### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Input Voltage
Operating Range 26V
Overvoltage Protection
LM2931A, LM2931C (Adjustable) 60V
LM2931 50V

Internal Power Dissipation
(Note 2, Note 4)

Operating Ambient Temperature
Range

Maximum Junction Temperature
Storage Temperature Range
Lead Temp. (Soldering, 10 seconds)

Internally Limited

-40°C to +85°C

-40°C to +85°C

-65°C to +150°C

230°C

ESD Tolerance (Note 5)

#### **Electrical Characteristics for Fixed 3.3V Version**

 $V_{IN} = 14V$ ,  $I_{O} = 10$ mA,  $T_{II} = 25$ °C,  $C_{2} = 100$ µF (unless otherwise specified) (Note 2)

	Conditions	LM	LM2931-3.3	
Parameter		Тур	Limit (Note 3)	Units
Output Voltage		3.3	3.465 3.135	V <sub>MAX</sub> V <sub>MIN</sub>
	$4V \le V_{IN} \le 26V$ , $I_{O} = 100 \text{ mA}$ $-40^{\circ}\text{C} \le T_{J} \le 125^{\circ}\text{C}$		3.630 2.970	V <sub>MAX</sub> V <sub>MIN</sub>
Line Regulation	4V ≤ V <sub>IN</sub> ≤ 26V	4	33	mV <sub>MAX</sub>
Load Regulation	5mA ≤ I <sub>O</sub> ≤ 100mA	10	50	mV <sub>MAX</sub>
Output Impedance	100mA <sub>DC</sub> and 10mA <sub>rms</sub> , 100Hz - 10kHz	200		mΩ
Quiescent Current	$I_O \le 10$ mA, $4V \le V_{IN} \le 26V$ $-40$ °C $\le T_J \le 125$ °C	0.4	1.0	mA <sub>MAX</sub>
	$I_{O} = 100 \text{mA}, V_{IN} = 14 \text{V}, T_{J} = 25 ^{\circ}\text{C}$	15		mA
Output Noise Voltage	10Hz -100kHz, C <sub>OUT</sub> = 100μF	330		$\mu V_{rms}$
Long Term Stability		13		mV/1000 hr
Ripple Rejection	f <sub>O</sub> = 120Hz	80		dB
Dropout Voltage	$I_O = 10$ mA $I_O = 100$ mA	0.05 0.30	0.2 0.6	V <sub>MAX</sub>
Maximum Operational Input Voltage		33	26	V <sub>MIN</sub>
Maximum Line Transient	$R_L = 500\Omega$ , $V_O \le 5.5V$ , $T = 1ms$ , $t \le 100ms$	70	50	V <sub>MIN</sub>
Reverse Polarity Input Voltage, DC	$V_{O} \ge -0.3V, R_{L} = 500\Omega$	-30	-15	V <sub>MIN</sub>
Reverse Polarity Input Voltage, Transient	T = 1ms, τ ≤ 100ms, $R_L = 500Ω$	-80	-50	V <sub>MIN</sub>

#### **Electrical Characteristics for Fixed 5V Version**

 $V_{IN}$  = 14V,  $I_{O}$  = 10mA,  $T_{J}$  = 25°C, C2 = 100  $\mu F$  (unless otherwise specified) (Note 2)

	Conditions	LM293	LM2931A-5.0		LM2931-5.0	
Parameter		Тур	Limit (Note 3)	Тур	Limit (Note 3)	Units
Output Voltage		5	5.19 4.81	5	5.25 4.75	V <sub>MAX</sub> V <sub>MIN</sub>
	$6.0V \le V_{IN} \le 26V, I_{O} = 100 \text{mA}$ $-40^{\circ}\text{C} \le T_{J} \le 125^{\circ}\text{C}$		5.25 4.75		5.5 4.5	V <sub>MAX</sub> V <sub>MIN</sub>
Line Regulation	$9V \le V_{IN} \le 16V$ $6V \le V_{IN} \le 26V$	2 4	10 30	2 4	10 30	mV <sub>MAX</sub>
Load Regulation	5 mA ≤ I <sub>O</sub> ≤ 100mA	14	50	14	50	mV <sub>MAX</sub>
Output Impedance	100mA <sub>DC</sub> and 10mA <sub>rms</sub> , 100Hz -10kHz	200		200		mΩ
Quiescent Current	$I_O \le 10 \text{mA}, 6V \le V_{IN} \le 26V$ -40°C \le T_J \le 125°C	0.4	1.0	0.4 15	1.0	mA <sub>MAX</sub>
	$I_{O} = 100 \text{mA}, V_{IN} = 14 \text{V}, T_{J} = 25 ^{\circ}\text{C}$	15	30 5	15		mA <sub>MAX</sub> mA <sub>MIN</sub>
Output Noise Voltage	10Hz -100kHz, C <sub>OUT</sub> = 100μF	500		500		μV <sub>rms</sub>
Long Term Stability		20		20		mV/1000 hr
Ripple Rejection	f <sub>O</sub> = 120 Hz	80	55	80		dB <sub>MIN</sub>
Dropout Voltage	$I_{O} = 10 \text{mA}$ $I_{O} = 100 \text{mA}$	0.05 0.3	0.2 0.6	0.05 0.3	0.2 0.6	V <sub>MAX</sub>
Maximum Operational Input Voltage		33	26	33	26	V <sub>MIN</sub>
Maximum Line Transient	$R_L = 500\Omega$ , $V_O \le 5.5V$ , $T = 1$ ms, $\tau \le 100$ ms	70	60	70	50	V <sub>MIN</sub>
Reverse Polarity Input Voltage, DC	$V_O \ge -0.3V$ , $R_L = 500\Omega$	-30	-15	-30	-15	V <sub>MIN</sub>
Reverse Polarity Input Voltage, Transient	T = 1ms, τ ≤ 100ms, $R_L = 500Ω$	-80	-50	-80	-50	V <sub>MIN</sub>

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device beyond its rated operating conditions.

Note 2: See circuit in Typical Applications. To ensure constant junction temperature, low duty cycle pulse testing is used.

Note 3: All limits are guaranteed for  $T_J = 25^{\circ}$ C (standard type face) or over the full operating junction temperature range of  $-40^{\circ}$ C to  $+125^{\circ}$ C (bold type face).

Note 4: The maximum power dissipation is a function of maximum junction temperature  $T_{Jmax}$ , total thermal resistance  $\theta_{JA}$ , and ambient temperature  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{Jmax} - T_A)/\theta_{JA}$ . If this dissipation is exceeded, the die temperature will rise above 150°C and the LM2931 will go into thermal shutdown. For the LM2931 in the TO-92 package,  $\theta_{JA}$  is 195°C/W; in the SO-8 package,  $\theta_{JA}$  is 160°C/W, and in the TO-220 package,  $\theta_{JA}$  is 50°C/W; in the TO-263 package,  $\theta_{JA}$  is 73°C/W; and in the 6-Bump micro SMD package  $\theta_{JA}$  is 290°C/W. If the TO-220 package is used with a heat sink,  $\theta_{JA}$  is the sum of the package thermal resistance junction-to-case of 3°C/W and the thermal resistance added by the heat sink and thermal interface

If the TO-263 package is used, the thermal resistance can be reduced by increasing the P.C. board copper area thermally connected to the package: Using 0.5 square inches of copper area,  $\theta_{JA}$  is 30°C/W; and with 1.6 or more square inches of copper area,  $\theta_{JA}$  is 32°C/W.

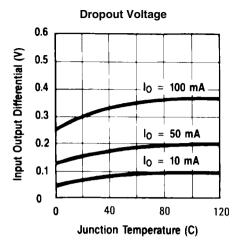
Note 5: Human body model, 100 pF discharged through 1.5 k $\Omega$ .

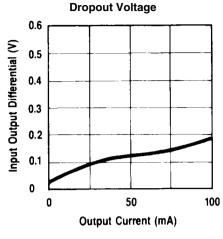
# **Electrical Characteristics for Adjustable Version**

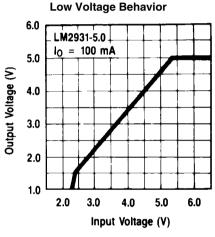
 $V_{IN}$  = 14V,  $V_{OUT}$  = 3V,  $I_{O}$  = 10 mA,  $T_{J}$  = 25°C, R1 = 27k, C2 = 100  $\mu$ F (unless otherwise specified) (Note 2)

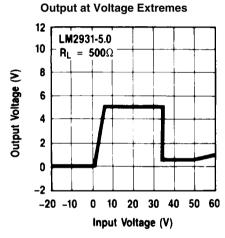
Parameter	Conditions	Тур	Limit	Units Limit
Reference Voltage		1.20	1.26	V <sub>MAX</sub>
			1.14	V <sub>MIN</sub>
	$I_0 \le 100 \text{ mA}, -40^{\circ}\text{C} \le T_i \le 125^{\circ}\text{C}, R1 = 27\text{k}$		1.32	V <sub>MAX</sub>
	Measured from V <sub>OUT</sub> to Adjust Pin		1.08	V <sub>MIN</sub>
Output Voltage Range			24	V <sub>MAX</sub>
			3	V <sub>MIN</sub>
Line Regulation	$V_{OUT} + 0.6V \le V_{IN} \le 26V$	0.2	1.5	mV/V <sub>MAX</sub>
Load Regulation	5 mA ≤ I <sub>O</sub> ≤ 100 mA	0.3	1	% <sub>MAX</sub>
Output Impedance	100 mA <sub>DC</sub> and 10 mA <sub>rms</sub> , 100 Hz–10 kHz	40		mΩ/V
Quiescent Current	I <sub>O</sub> = 10 mA	0.4	1	mA <sub>MAX</sub>
	I <sub>O</sub> = 100 mA	15		mA
	During Shutdown R <sub>L</sub> = $500\Omega$	0.8	1	mA <sub>MAX</sub>
Output Noise Voltage	10 Hz-100 kHz	100		μV <sub>rms</sub> /V
Long Term Stability		0.4		%/1000 hr
Ripple Rejection	f <sub>O</sub> = 120 Hz	0.02		%/V
Dropout Voltage	I <sub>O</sub> ≤ 10 mA	0.05	0.2	V <sub>MAX</sub>
	I <sub>O</sub> = 100 mA	0.3	0.6	V <sub>MAX</sub>
Maximum Operational Input				
Voltage		33	26	V <sub>MIN</sub>
Maximum Line Transient	I <sub>O</sub> = 10 mA, Reference Voltage ≤ 1.5V	70	60	V <sub>MIN</sub>
	T = 1 ms, τ ≤ 100 ms			
Reverse Polarity Input	$V_O \ge -0.3V$ , $R_L = 500\Omega$			
Voltage, DC		-30	-15	V <sub>MIN</sub>
Reverse Polarity Input	T = 1 ms, τ ≤ 100 ms, $R_L = 500\Omega$			
Voltage, Transient		-80	-50	V <sub>MIN</sub>
On/Off Threshold Voltage	V <sub>O</sub> =3V			
On		2.0	1.2	V <sub>MAX</sub>
Off		2.2	3.25	V <sub>MIN</sub>
On/Off Threshold Current		20	50	μA <sub>MAX</sub>

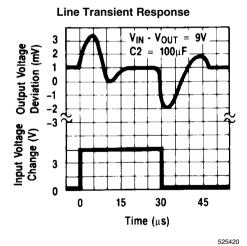
# **Typical Performance Characteristics**







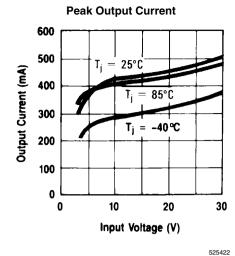


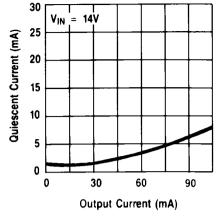


Load Transient Response

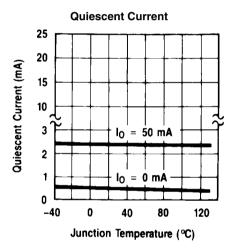
40 C2 = 100 \( \text{LT} \)

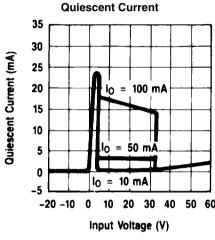
Onto the total or the total o

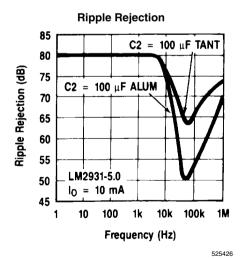


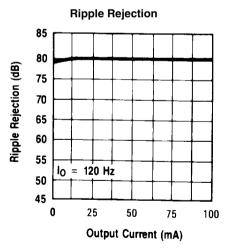


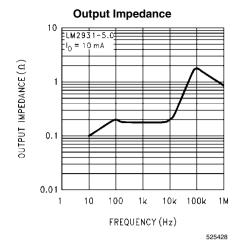
**Quiescent Current** 

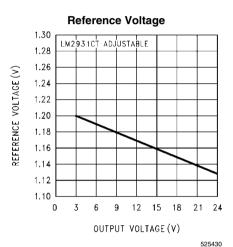


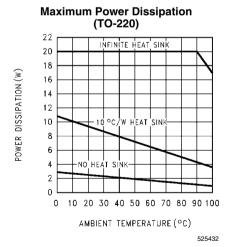


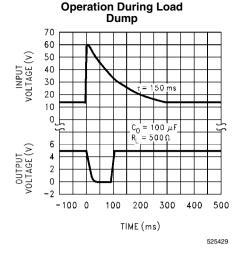


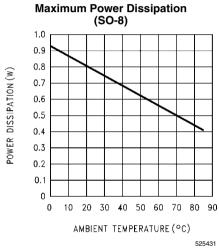


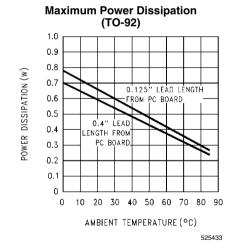




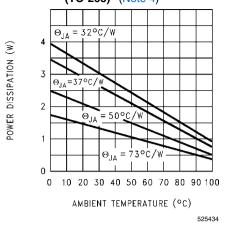




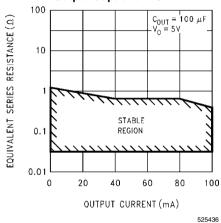




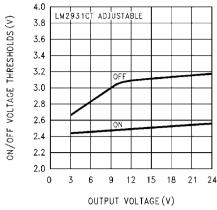
#### **Maximum Power Dissipation** (TO-263) (Note 4)



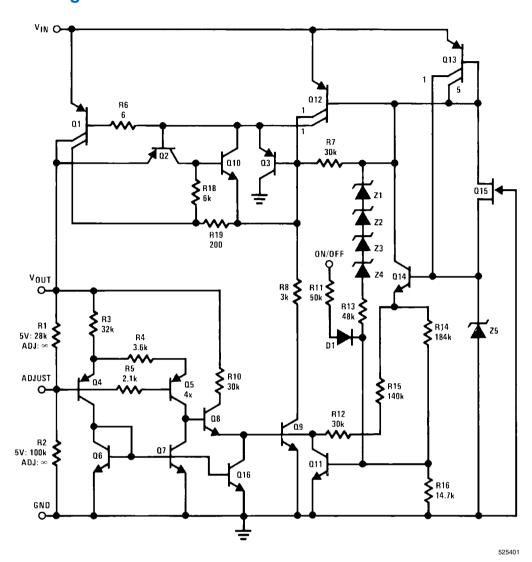
#### **Output Capacitor ESR**



#### On/Off Threshold



# **Schematic Diagram**



#### **Application Hints**

One of the distinguishing factors of the LM2931 series regulators is the requirement of an output capacitor for device stability. The value required varies greatly depending upon the application circuit and other factors. Thus some comments on the characteristics of both capacitors and the regulator are in order.

High frequency characteristics of electrolytic capacitors depend greatly on the type and even the manufacturer. As a result, a value of capacitance that works well with the LM2931 for one brand or type may not necessary be sufficient with an electrolytic of different origin. Sometimes actual bench testing, as described later, will be the only means to determine the proper capacitor type and value. Experience has shown that, as a rule of thumb, the more expensive and higher quality electrolytics generally allow a smaller value for regulator stability. As an example, while a high-quality 100  $\mu F$  aluminum electrolytic covers all general application circuits, similar stability can be obtained with a tantalum electrolytic of only  $47\mu F$ . This factor of two can generally be applied to any special application circuit also.

Another critical characteristic of electrolytics is their performance over temperature. While the LM2931 is designed to operate to -40°C, the same is not always true with all electrolytics (hot is generally not a problem). The electrolyte in many aluminum types will freeze around -30°C, reducing their effective value to zero. Since the capacitance is needed for regulator stability, the natural result is oscillation (and lots of it) at the regulator output. For all application circuits where cold operation is necessary, the output capacitor must be rated to operate at the minimum temperature. By coincidence, worst-case stability for the LM2931 also occurs at minimum temperatures. As a result, in applications where the regulator junction temperature will never be less than 25°C, the output capacitor can be reduced approximately by a factor of two over the value needed for the entire temperature range. To continue our example with the tantalum electrolytic, a value of only 22µF would probably thus suffice. For high-quality aluminum, 47µF would be adequate in such an application.

Another regulator characteristic that is noteworthy is that stability decreases with higher output currents. This sensible fact has important connotations. In many applications, the LM2931 is operated at only a few milliamps of output current or less. In such a circuit, the output capacitor can be further reduced in value. As a rough estimation, a circuit that is required to deliver a maximum of 10mA of output current from the regulator would need an output capacitor of only half the value compared to the same regulator required to deliver the full output current of 100mA. If the example of the tantalum capacitor in the circuit rated at 25°C junction temperature and above were continued to include a maximum of 10mA of output current, then the 22 $\mu$ F output capacitor could be reduced to only 10 $\mu$ F.

In the case of the LM2931CT adjustable regulator, the minimum value of output capacitance is a function of the output voltage. As a general rule, the value decreases with higher output voltages, since internal loop gain is reduced.

At this point, the procedure for bench testing the minimum value of an output capacitor in a special application circuit should be clear. Since worst-case occurs at minimum operating temperatures and maximum operating currents, the entire circuit, including the electrolytic, should be cooled to the minimum temperature. The input voltage to the regulator should be maintained at 0.6V above the output to keep internal power dissipation and die heating to a minimum. Worst-case occurs just after input power is applied and before the die has had a chance to heat up. Once the minimum value of capacitance has been found for the brand and type of electrolytic in question, the value should be doubled for actual use to account for production variations both in the capacitor and the regulator. (All the values in this section and the remainder of the data sheet were determined in this fashion.)

#### LM2931 micro SMD Light Sensitivity

When the LM2931 micro SMD package is exposed to bright sunlight, normal office fluorescent light, and other LED's, it operates within the guaranteed limits specified in the electrical characteristic table.

#### **Definition of Terms**

**Dropout Voltage:** The input-output voltage differential at which the circuit ceases to regulate against further reduction in input voltage. Measured when the output voltage has dropped 100 mV from the nominal value obtained at 14V input, dropout voltage is dependent upon load current and junction temperature.

**Input Voltage:** The DC voltage applied to the input terminals with respect to ground.

**Input-Output Differential:** The voltage difference between the unregulated input voltage and the regulated output voltage for which the regulator will operate.

**Line Regulation:** The change in output voltage for a change in the input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that the average chip temperature is not significantly affected.

**Load Regulation:** The change in output voltage for a change in load current at constant chip temperature.

Long Term Stability: Output voltage stability under accelerated life-test conditions after 1000 hours with maximum rated voltage and junction temperature.

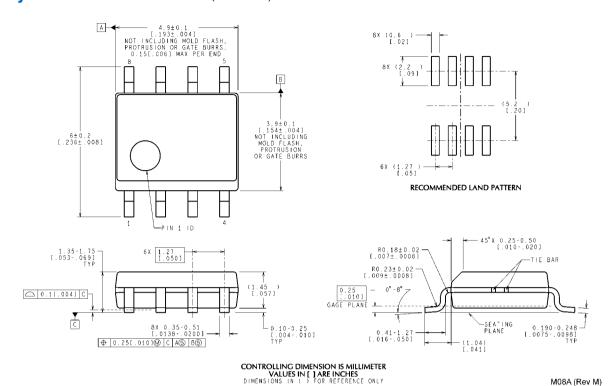
**Output Noise Voltage:** The rms AC voltage at the output, with constant load and no input ripple, measured over a specified frequency range.

**Quiescent Current:** That part of the positive input current that does not contribute to the positive load current. The regulator ground lead current.

**Ripple Rejection:** The ratio of the peak-to-peak input ripple voltage to the peak-to-peak output ripple voltage at a specified frequency.

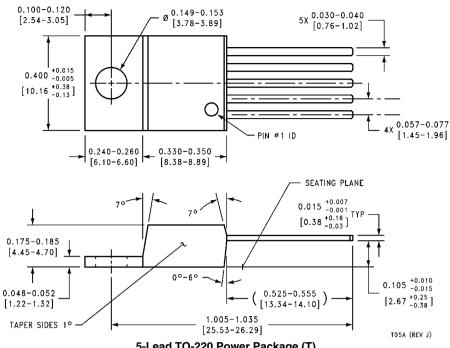
**Temperature Stability of V\_0:** The percentage change in output voltage for a thermal variation from room temperature to either temperature extreme.

#### Physical Dimensions inches (millimeters) unless otherwise noted

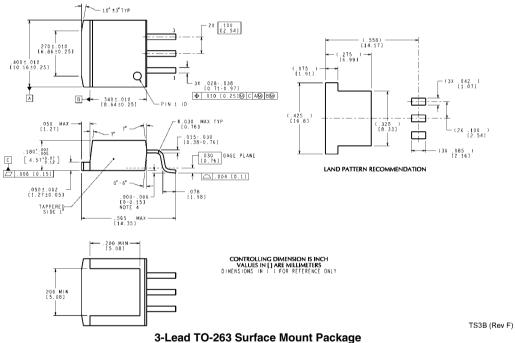


8-Lead Surface Mount Package (M) NS Package Number M08A

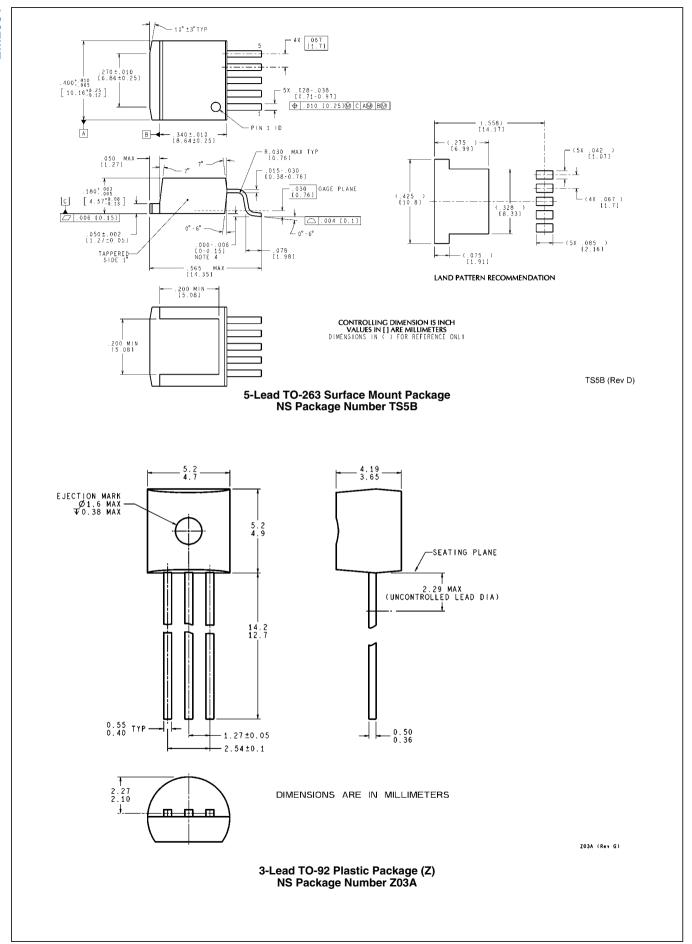
0.240-0.260 0.330-0.350 [6.10-6.60] [8.38-8.89] 0.100-0.120 ø 0.149-0.153 [2.54-3.05] [3.78-3.89] 0.090-0.110 0.400 +0.015 [2.29-2.79] 0.190-0.210 [10.16 +0.38 ] [4.83-5.33] 0.048-0.055 0.130-0.160 TYP [1.22-1.40] TYP [3.30-4.06] PIN #1 ID 0.027-0.037 1.005-1.035 [0.69-0.94] [25.53-26.29] TYP  $0.015 \, {}^{+0.007}_{-0.001} \, \big[ 0.38 \, {}^{+0.18}_{-0.03} \big]$ 0.525-0.555 [13.34-14.10] 0.175-0.185 [4.45-4.70]  $0.105 \, {}^{+0.010}_{-0.015} \, [ 2.67 \, {}^{+0.25}_{-0.38} \, ]$ 0.048-0.052 [1.22-1.32] SEATING PLANE TAPERED SIDES 1º TO3B (REV L) 3-Lead TO-220 Plastic Package (T) NS Package Number T03B

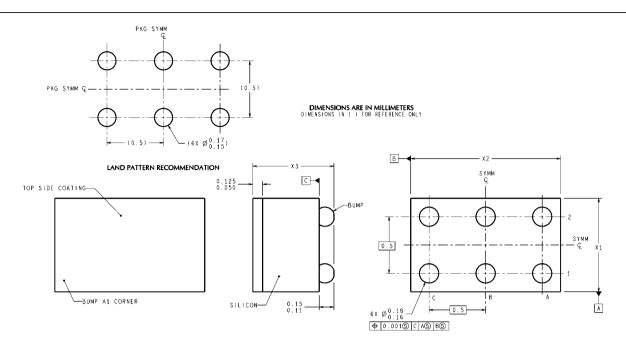


5-Lead TO-220 Power Package (T) NS Package Number T05A



NS Package Number TS3B





BPA06XXX (Rev D)

NOTE: UNLESS OTHERWISE SPECIFIED.

- 1. EPOXY COATING.
- 2. 63Sn/37Pb EUTECTIC BUMP.
- 3. RECOMMEND NON-SOLDER MASK DEFINED LANDING PAD.
- 4. PIN A1 IS ESTABLISHED BY LOWER LEFT CORNER WITH RESPECT TO TEST ORIENTATION PINS ARE NUMBERED COUNTERCLOCKWISE.
- $5. XXX IN DRAWING NUMBER REPRESENTS PACKAGE SIZE VARIATION WHERE <math>X_1$  IS PACKAGE WIDTH,  $X_2$  IS PACKAGE LENGTH AND  $X_3$  IS PACKAGE HEIGHT.
- 6. REFERENCE JEDEC REGISTRATION MO-211, VARIATION BC.

 $\begin{array}{ccc} & \text{6-Bump micro SMD} \\ \text{NS Package Number BPA06HTB} \\ \text{X}_1 = 0.955 & \text{X}_2 = 1.717 & \text{X}_3 = 0.850 \\ \end{array}$ 

#### **Notes**

For more National Semiconductor product information and proven design tools, visit the following Web sites at: www.national.com

Pro	oducts	Design Support		
Amplifiers	www.national.com/amplifiers	WEBENCH® Tools	www.national.com/webench	
Audio	www.national.com/audio	App Notes	www.national.com/appnotes	
Clock and Timing	www.national.com/timing	Reference Designs	www.national.com/refdesigns	
Data Converters	www.national.com/adc	Samples	www.national.com/samples	
Interface	www.national.com/interface	Eval Boards	www.national.com/evalboards	
LVDS	www.national.com/lvds	Packaging	www.national.com/packaging	
Power Management	www.national.com/power	Green Compliance	www.national.com/quality/green	
Switching Regulators	www.national.com/switchers	Distributors	www.national.com/contacts	
LDOs	www.national.com/ldo	Quality and Reliability	www.national.com/quality	
LED Lighting	www.national.com/led	Feedback/Support	www.national.com/feedback	
Voltage References	www.national.com/vref	Design Made Easy	www.national.com/easy	
PowerWise® Solutions	www.national.com/powerwise	Applications & Markets	www.national.com/solutions	
Serial Digital Interface (SDI)	www.national.com/sdi	Mil/Aero	www.national.com/milaero	
Temperature Sensors	www.national.com/tempsensors	SolarMagic™	www.national.com/solarmagic	
PLL/VCO	www.national.com/wireless	PowerWise® Design University	www.national.com/training	

THE CONTENTS OF THIS DOCUMENT ARE PROVIDED IN CONNECTION WITH NATIONAL SEMICONDUCTOR CORPORATION ("NATIONAL") PRODUCTS. NATIONAL MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE ACCURACY OR COMPLETENESS OF THE CONTENTS OF THIS PUBLICATION AND RESERVES THE RIGHT TO MAKE CHANGES TO SPECIFICATIONS AND PRODUCT DESCRIPTIONS AT ANY TIME WITHOUT NOTICE. NO LICENSE, WHETHER EXPRESS, IMPLIED, ARISING BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT.

TESTING AND OTHER QUALITY CONTROLS ARE USED TO THE EXTENT NATIONAL DEEMS NECESSARY TO SUPPORT NATIONAL'S PRODUCT WARRANTY. EXCEPT WHERE MANDATED BY GOVERNMENT REQUIREMENTS, TESTING OF ALL PARAMETERS OF EACH PRODUCT IS NOT NECESSARILY PERFORMED. NATIONAL ASSUMES NO LIABILITY FOR APPLICATIONS ASSISTANCE OR BUYER PRODUCT DESIGN. BUYERS ARE RESPONSIBLE FOR THEIR PRODUCTS AND APPLICATIONS USING NATIONAL COMPONENTS. PRIOR TO USING OR DISTRIBUTING ANY PRODUCTS THAT INCLUDE NATIONAL COMPONENTS, BUYERS SHOULD PROVIDE ADEQUATE DESIGN, TESTING AND OPERATING SAFEGUARDS.

EXCEPT AS PROVIDED IN NATIONAL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, NATIONAL ASSUMES NO LIABILITY WHATSOEVER, AND NATIONAL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY RELATING TO THE SALE AND/OR USE OF NATIONAL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS PRIOR WRITTEN APPROVAL OF THE CHIEF EXECUTIVE OFFICER AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

Life support devices or systems are devices which (a) are intended for surgical implant into the body, or (b) support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in a significant injury to the user. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system or to affect its safety or effectiveness.

National Semiconductor and the National Semiconductor logo are registered trademarks of National Semiconductor Corporation. All other brand or product names may be trademarks or registered trademarks of their respective holders.

Copyright© 2011 National Semiconductor Corporation

For the most current product information visit us at www.national.com



National Semiconductor Americas Technical Support Center Email: support@nsc.com Tel: 1-800-272-9959 National Semiconductor Europe Technical Support Center Email: europe.support@nsc.com National Semiconductor Asia Pacific Technical Support Center Email: ap.support@nsc.com

National Semiconductor Japan Technical Support Center Email: jpn.feedback@nsc.com